

SM1231 RF MODULE

USER GUIDE

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1 Introduction

The purpose of this tool is to provide a development platform of the SX1231. User can build his application prototype by simply connecting the module to his target microcontroller and start developing his application software. The SM1231 module integrates the SX1231 reference design (chip + external components) plus miscellaneous useful connectors.

Note that this module is also used for the SX1231SKB Evaluation Kit.

It is recommended that this user guide be read in conjunction with the SX1231 datasheet.

2 Reference Design

As illustrated in Figure 1, below, the SM1231 reference design module consists of the following:

- Reference Design: This section includes the chip but also all the external components in an optimized BOM and form factor. When the user wishes to incorporate the SX1231 to PCB, it is strongly recommended that this reference design (i.e. schematics, placement, layout, BOM, etc...) is copied "as is" in the final application board to guarantee optimum performance, regulatory compliance and lowest development time and design effort.
- MCU Connector: Enables the user to connect the SX1231 control and interface pins to the host microcontroller (please refer to the SX1231 datasheet for further information).

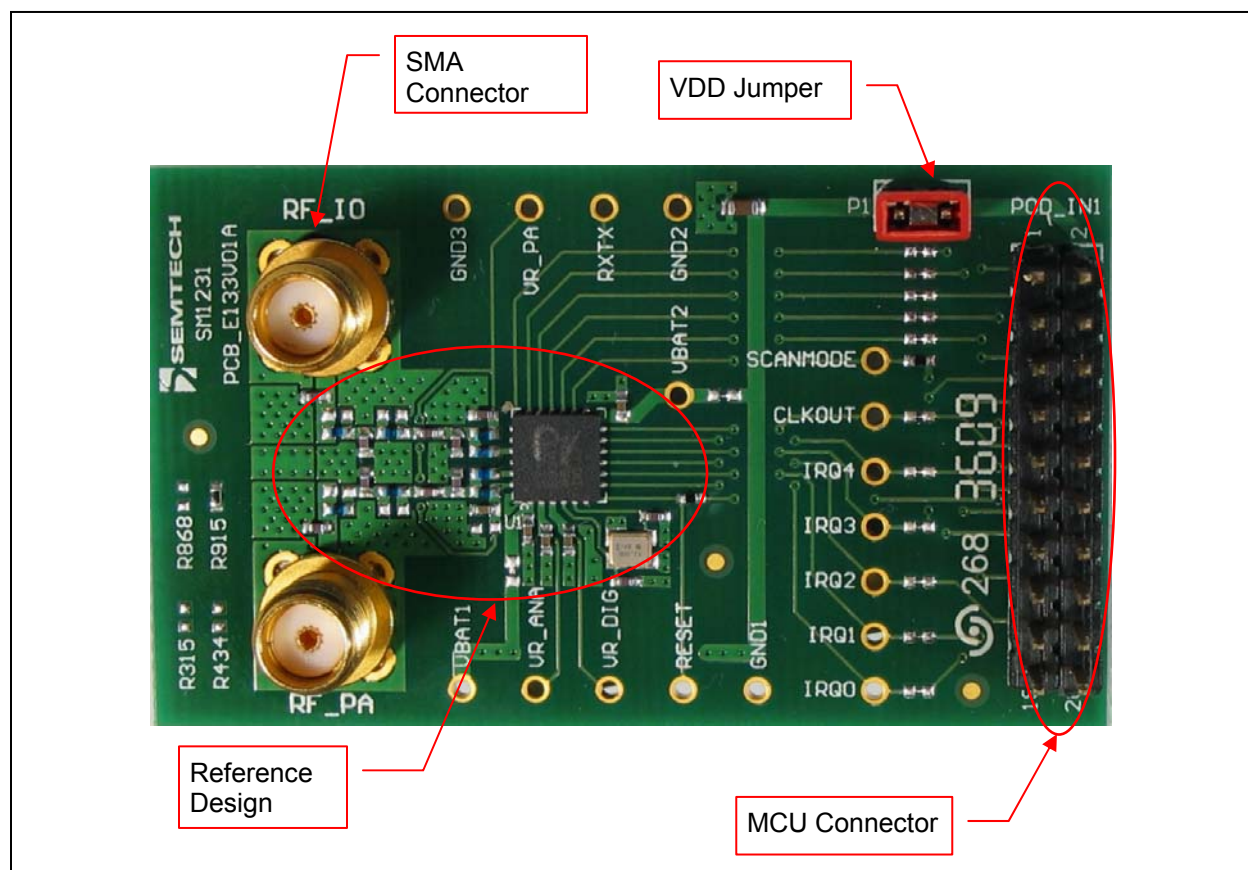


Figure 1: SM1211 Overview (Top View)

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- SMA Connector: Provided for SMA Cable or antenna connection. Each board is delivered with a quarter-wave SMA antenna appropriate to the frequency band of operation. Note that the SM1231 module has two independent connectorized RF ports; RF_IO, the common LNA and low power transmitter PA port and RF_PA, the high power transmitter port.
- VDD jumper: Enables current consumption to be monitored and / or apply independent power supply to the module. When VDD jumper is made, power should be supplied via the MCU connector.

The pin-out of the MCU connector is tabulated below in Table 1.

PIN #	NAME	TYPE	DESCRIPTION
1	SCK	I	SPI Clock Input
2	VDD	I	Supply Voltage Connection
3	MOSI	I	SPI Data Input
4	GND	-	Ground Connection
5	DIO1/DCLK	I/O	Digital I/O, Software Configurable
6	DIO3	I/O	Digital I/O, Software Configurable
7	NSS	I	SPI Chip Select
8	MISO	O	SPI Data Output
9	DIO5	I/O	Digital I/O, Software Configurable
10	RESET	I/O	Reset Trigger Input / POR Flag
11	DIO4	I/O	Digital I/O, Software Configurable
12	DIO0	-	Digital I/O, Software Configurable
13	RXTX	O	RX/TX Switch Control; High in TX
14	-	-	Not Connected
15	DIO1/DCLK	I/O	Digital I/O, Software Configurable
16	-	-	Not Connected
17	DIO2/DATA	I/O	Digital I/O, Software Configurable
18	-	-	Not Connected
19	-	-	Not Connected
20	-	-	Not Connected

Table 1: MCU Connector Pin Description

The SM1231 reference design is available for download from the Semtech website, and contains the latest schematic, PCB Gerber files and BOMs for 315 MHz, 434 MHz, 868 MHz and 915 MHz frequency bands of operation.

The SM1231 Schematic diagram is illustrated in Figure 2.

Software drivers are available for the SX1231 and can be found in technical note TN8000.18 and source code ("XE8000 Driving XE1200 Transceivers Standard API Definitions") available for download from the Semtech website.

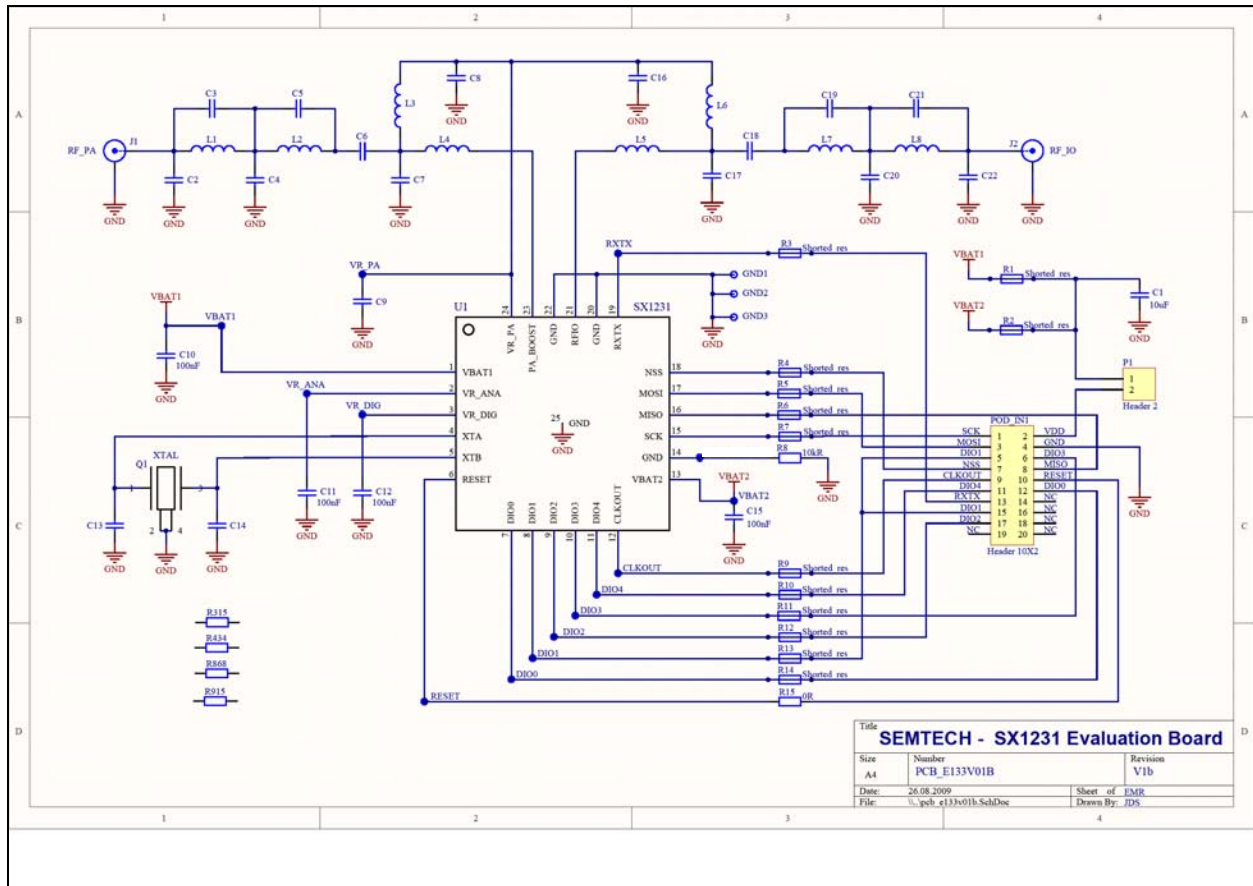
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Figure 2: SM1231 Schematic Diagram

3 PCB Layout

As illustrated below in Figure 3, the SM1231 reference design PCB layout has the following characteristics:

- Compact active area reference design () which can easily be accommodated in a very small PCB
- Standard PCB technology (2 layers, 1.6 mm / 63 mils FR4 dielectric)

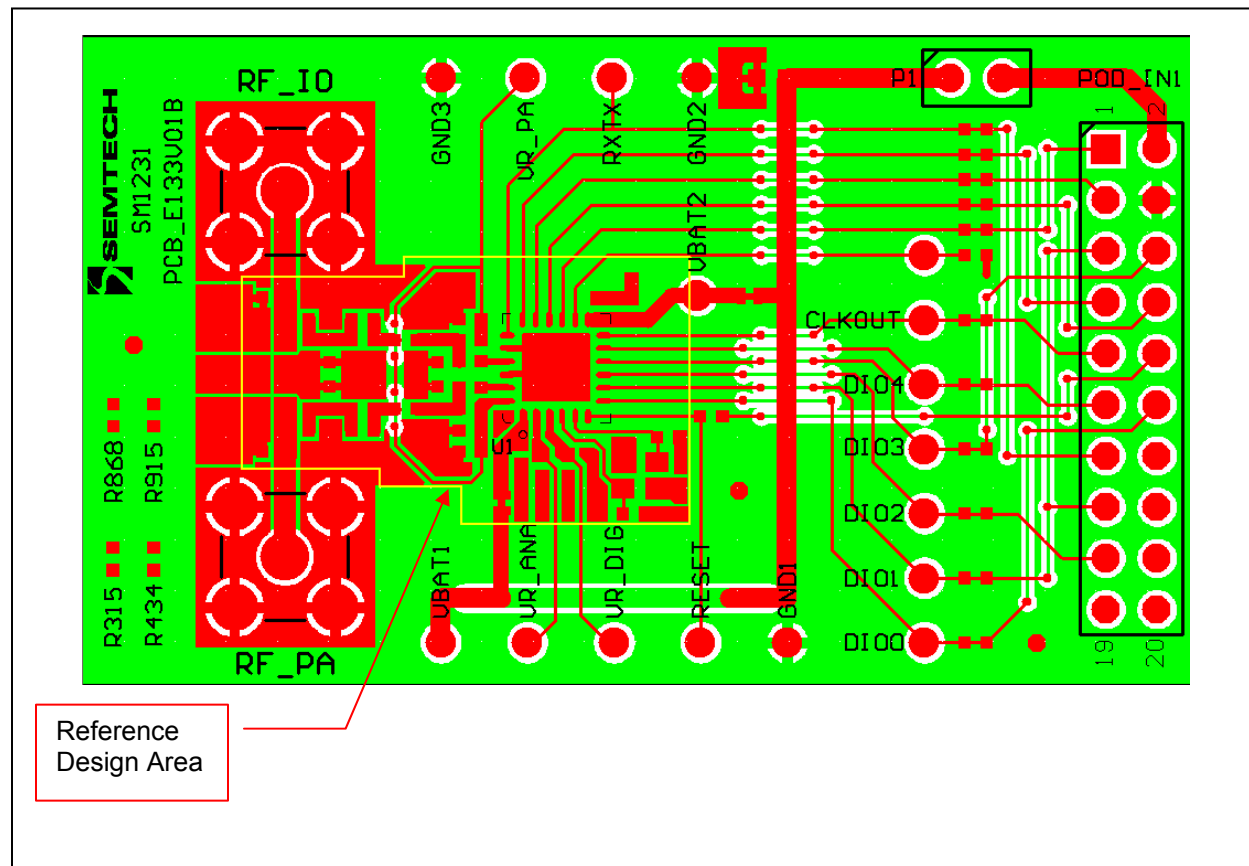


Figure 3: SM1231 PCB Layout (Top View)

4 BOM

An example BOM for the 915 MHz variant of the SM1231 is tabulated in Table 2.

REF	VALUE	TOL ($\pm$)	SIZE	COMMENT
U1	SX1231	-	VQFN24	SX1231 Low-Power UHF Integrated Transceiver
R15	0R	1%	0402	External RESET pin
C1	10 μ F	20%	0603	Decoupling
C2	3.3pF	0.25pF	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C3	N/F	-	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C4	6.8pF	0.5pF	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C5	N/F	-	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C6	22pF	5%	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C7	8.2pF	0.5pF	0402	PA_BOOST Matching (Comp. Value is Band Specific)
C8	10nF	10%	0402	Decoupling
C10	100nF	10%	0402	Decoupling
C11	100nF	10%	0402	Decoupling
C12	100nF	5%	0402	Decoupling
C13	15pF	5%	0402	Crystal Load Capacitor
C14	15pF	5%	0402	Crystal Load Capacitor
C15	100nF	10%	0402	Decoupling
C16	68pF	5%	0402	Decoupling
C17	4.7pF	0.25pF	0402	RFIO Matching (Comp. Value is Band Specific)
C18	8.2pF	5%	0402	RFIO Matching (Comp. Value is Band Specific)
C19	N/F	-	0402	RFIO Matching (Comp. Value is Band Specific)
C20	6.8pF	0.5pF	0402	RFIO Matching (Comp. Value is Band Specific)
C21	N/F	-	0402	RFIO Matching (Comp. Value is Band Specific)
C22	5.6pF	0.5pF	0402	RFIO Matching (Comp. Value is Band Specific)
L1	5.6nH	0.2nH	0402	PA_BOOST Matching (Comp. Value is Band Specific)
L2	5.6nH	0.2nH	0402	PA_BOOST Matching (Comp. Value is Band Specific)
L3	22nH	5%	0402	PA_BOOST Matching (Comp. Value is Band Specific)
L4	2.7nH	0.5nH	0402	PA_BOOST Matching (Comp. Value is Band Specific)
L5	3.9nH	0.2nH	0402	RFIO Matching (Comp. Value is Band Specific)
L6	33nH	5%	0402	RFIO Matching (Comp. Value is Band Specific)
L7	6.8nH	5%	0402	RFIO Matching (Comp. Value is Band Specific)
L8	6.8nH	5%	0402	RFIO Matching (Comp. Value is Band Specific)
Q1	32.000MHz	-	NX2520SA	NDK Surface mount type crystal $\pm$ 10ppm, CLoad=10pF

Table 2: SM1231 915 MHz BOM

5 References

- SX1231 Datasheet
- TN8000.18 Technical Note "XE8000 driving XE1200 transceivers Standard API definitions"

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Contact information

Semtech Corporation
Advanced Communication and Sensing Products Division
200 Flynn Road, Camarillo, CA 93012
Phone: (805) 498-2111 Fax: (805) 498-3804
E-mail: sales@semtech.com
Support: Support_RF@semtech.com
Internet: <http://www.semtech.com>



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Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.